

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
BIAO LI	04/05/2012
RECEIVING PARTY DATA	
Name:	FuKui Precision Component (Shenzhen) Co., Ltd.
Street Address:	XinYuan Industrial Zone, Tangwei Village, Fuyong Town, Bao' an District
City:	Shenzhen City, Guangdong Province
State/Country:	CHINA
Name:	Zhen Ding Technology Co., Ltd.
Street Address:	No. 6, Lane 28, San Ho Rd., San Shi Village
City:	Tayuan, Taoyuan
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13441932
CORRESPONDENCE DATA	
Fax Number:	(909)978-6366
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Email:	ea-altis@foxconn.com, ea-itec@foxconn.com, ea-proce@foxconn.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
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Address Line 1:	288 South Mayo Avenue
Address Line 4:	City of Industry, CALIFORNIA 91789
ATTORNEY DOCKET NUMBER:	US41332
NAME OF SUBMITTER:	Raymond J. Chew
Total Attachments: 2 source=US41332120405ASM#page1.tif source=US41332120405ASM#page2.tif	

CH \$40.00 13441932

PATENT

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. BIAO LI , residing at Shenzhen, Guangdong, China
- 2. _____ , residing at _____
- 3. _____ , residing at _____
- 4. _____ , residing at _____
- 5. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **FUKUI PRECISION COMPONENT (SHENZHEN) CO., LTD.** having a principal place of business at **XinYuan Industrial Zone, Tangwei Village, Fuyong Town, Baoan District, Shenzhen City , Guangdong Province 518103, P.R.C** and **ZHEN DING TECHNOLOGY CO., LTD.** having a principal place of business at **No. 6, Lane 28, San Ho Rd., San Shi Village, Tayuan, Taoyuan, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **METHOD FOR MANUFACTURING RIGID-FLEXIBLE PRINTED CIRCUIT BOARD** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Biao Li</u> BIAO LI	<u>2012/4/5</u> Date
2.	_____	_____ Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date